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Parallel detection in liquid phase of N-channel

MOSFET/ChemFET microdevices using saturation mode

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Abstract

MOSFET and ChemFET are currently being used in many types of applications for

the measurement of electrochemical potential and pH in liquid phase. This paper presents the

realization of an analysis micro device including the micro sensor chip, the on-board

electronic and the associated fluidics. The whole micro system can be easily transported, used

for cellular cultures monitoring or chemical test thanks to a specific electronic interface.

Using the transistor saturation mode, this interface enables both static and dynamic

measurements for ChemFET and MOSFET-based devices, reducing electrical measurement

interferences (up to 50dB) coming from the liquid phase.

Keywords: MOSFET, ChemFET, dynamic measurements, on board electronics

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Introduction

Research in the field of biosensors has enormously increased over the recent years, dealing with numerous detection/transduction principles. In the frame of electrochemistry, amperometry and potentiometry were especially developed. As a result, among the large range of biosensors, two kinds of integrated sensors rose: microelectrodes [1] and chemical field effect transistors (ChemFET) [2]. Each microsensors family has their own drawbacks and advantages and are finally complementary, offering a large panel of biological analysis [1-4]. Nevertheless, although the use of silicon-based technology deviated from microelectronics, both of them allow the development of micro/nanodevices networks to deal with multi-analysis strategies. This was demonstrated for CMOS-based microelectrode arrays [5] and successfully realized for the genome sequencing using ChemFET-based CMOS technology [6]. Furthermore, this multi-analysis approach is also fully compatible with the monitoring of cells cultures, leading to the realization of multi electrode arrays (MEA) and metal-oxide-semiconductor field effect transistor (MOSFET) based integrated circuits. Both technologies were used for the measurement of cellular electrochemical parameters [7-9] and of neuronal activities [10,11]. Nevertheless, compared to the MEA one, the FET technology was shown to be more adapted for such application. Indeed, the use of an inert upper oxide layer allows a direct measurement and contact with cells while preventing any interfering electrochemical reactions or any biological troubles [12]. Thus, Fromherz et al. have demonstrated that it can be possible to measure action potentials using MOSFET-based devices [13,14] and others works related to neural cells [15,16] or neural cultures [17] were successfully developed and presented in the literature. In this frame, one of the main interests is related to the monitoring of neurons network thanks to an integrated MOSFET and/or ChemFET array. However, when it comes to such complex bio-electronics interfaces, one of the measurement drawbacks is related to the complex microenvironment-related electrochemical noise and/or interferences that can hide the biological signal to be measured. As a result, it is important to control interferences voltages and currents coming from the water-based, conductive, analysis solution. In this article, a strategy to optimize the bioelectronics interface is addressed while using MOSFET and ChemFET microdevices for a parallel analysis of neurons cells in liquid phase.

Experimental procedure

A. MOSFET/ChemFET microdevices fabrication

The field-effect transistors (FET) transistor micro devices fabrication is based on a standard ChemFET technology [18]. Yet, by introducing a specific metallization step in the fabrication process, both ChemFET and MOSFET microdevices were realized at once. Thus, the final chip includes 16 field-effect transistors suited to parallel detection. The starting substrate is a 6 inches, <100>, N-type silicon wafer (resistivity of 400 Ω .cm). The electrical insulation between each transistor was realized thanks to a standard P-well technology based on a Boron (B) implantation with a dose of $5x10^{11}$ cm⁻². Then, arsenic (As) implantation was performed with a dose of 10¹⁶ cm⁻². In order to realize N-doped source and drain zones, a 50nm thermal oxide (SiO₂) layer and a 50nm silicon nitride (Si₃N₄) layer sequentially developed formed the pH-sensitive gate area. Finally, after opening the source and drain contact zones, lift-off process was used to pattern a Titanium/Gold (Ti/Au) layer used for metallization contact and gate. Meanwhile, large area (~ 7850µm²) Ti/Au microelectrodes were integrated to be used as non-ideal-reference electrode in order to ground the liquid media. After this step, pH-ChemFET (SiO₂/Si₃N₄ gate) and MOSFET (SiO₂/Si₃N₄/Ti/Au gate) microdevices were completed (Fig. 1). At the end, two kind of chips were realized, one with 12 pH-ChemFET and 4 MOSFET (Fig. 2 a) and the other with 16 MOSFET (Fig. 2 b).

Finally, wafer-level packaging process was performed using the SU-8 technology. In our case, SU-8, a commonly used epoxy-based negative photo-resist was used to define the gate area, to passivate the chip surface, to isolate the electrical connections from the liquid environment and to fabricate fluidic micro devices while using the "stepper technology" in a non-standard way [19].

B. Packaging process

The line of sight of our FETs sensing platform is the activity monitoring of neurons culture. For this to be successfully achieved, analysis microdevices have to be realized in order to take into account specific physical and/or biochemical treatments: cleaning, sterilization, incubation processes. As a result, a special packaging process was developed in terms of silicon chip, printed circuit board (PCB), connectors and glass ring, inspired by Hierlemann works [5,10]. To meet the different requirements, chips are assembled on

individual PCB supports. The chip packaging on PCB was realized using the "Flip-Chip" technique. This method allows a direct connection between the chip and its support by avoiding wire bonding. However, in such configuration an opening must be realized in the PCB in order to have a convenient access to the chip. As every chip has forty pads of connection, the screen printing technique coupled with the under bump metallurgy (UBM) one was the best method to collectively deposit as many bumps as needed on the PCB (Fig. 3 a). Finally, using adapted temperature and pressure parameters, the chips were fully mounted (Fig. 3 b).

In order to avoid contact with the liquid phase, metallic connections and bumps were protected using the "Under fill" technique. A biocompatible epoxy resin (E301 from Epotek) was used because of its low viscosity (200cps) and its thermal reticulation at room temperature. Eventually, to finish the packaging process and integrate a fluidic analysis tank on top of the chip, a Pyrex ring was stuck to the printed circuit board using another biocompatible epoxy resin (E353ND-T from Epotek) with a high viscosity (10000 cps). Thus, the whole micro system including the ChemFET/MOSFET chip, the waterproof tank and the printed circuit board designed to be easily plugged in an electronic interface, was finally realized (Fig. 4).

C. Experimental set-up

Before its realization, the electronic interface was designed and simulated using P-Spice software. According to the simulations results and in agreement with the ChemFET/MOSFET implemented technology, the FET-based microdevices were biased using a drain-source current I_{DS} and a drain-source voltage V_{DS} respectively equal to 250μ A and 2V. For the liquid phase analysis, three kinds of reference electrodes were tested to bias the liquid sample to the ground (V_G = 0V): the Ti/Au microelectrode integrated on the chip, a gold wire and a commercial silver / silver chloride Ag/AgCl reference electrode (purchased from Metrohm). Furthermore, supplementary Ti/Au integrated microelectrodes on the chip were used to measure in parallel and simultaneously the potentiometric noise V_{Noise} . Whatever the microdevices tested, i.e. ChemFET or MOSFET, all these measurement parameters were kept constant.

Since our ChemFET technology was previously characterized in previous work [18], a simple test was performed in order to check the electrochemical behavior. Thus, three different pH buffered solutions (pH = 4.0, 7.0, 10.0, purchased from Sigma) were studied

while using the commercial Ag/AgCl reference electrode. For the first buffer (pH = 4.0), all natural offsets of each ChemFET transistor were deduced and removed automatically by the oscilloscope so as to have only static variations generated by the pH ones.

Concerning MOSFET devices, they were first tested in a classical way by current-voltage experiment to check their electrical characteristics. Then, same devices were studied in liquid samples while mimicking neuronal signals. In order to do so, different artificial electrical action potential-like voltages (a -70 mV resting potential and extremum voltage of -100mV and +30mV) were generated by a signal generator (AFG3102 from Tektronix) and applied to different MOSFET gates to test their electrical behavior as well as the independence of their respective electrical measurement. Such experiments were performed in three different liquid media, i.e. deionized water, phosphate buffered solution (PBS, pH = 7.4, purchased from Sigma) and Dubelcco's Modified Eagle's medium (DMEM) culture field (purchased from Hyclone), using the three different electrodes to bias the liquid phase, i.e. the Ti/Au integrated one, the gold wire and the Ag/AgCl commercial one.

Results and discussion

A. Electronic formalism

In this work, the electronic scheme is based on the saturation mode. This configuration allows reducing the field noise due to adapted feedback control while ensuring the exclusive measurement of signals generated by biological phenomena. From the electrical point of view, the studied chip is associated to a FET network which vocation is to measure any electrochemical variation on the FET's metallic gates or pH-sensitive surfaces. It is assumed that all the field effect transistors have conventional behaviour and obey to the well-known equations between the drain-source current I_{DS} , the drain-source voltage V_{DS} and the gate-source voltage V_{GS} . According to the imposed bias conditions, the FET-based devices are placed in the saturation mode ($V_{GS} > V_{th}$ and $V_{DS} > V_{GS} - V_{th}$). As a result, the drain-source current is:

$$I_{DS} = K(V_{GS} - V_T)^2 \left(1 + \frac{V_{DS}}{V_A}\right)$$
 (1)

where V_A is the Early's voltage, V_T is the FET threshold voltage and K stands for the MOSFET transistor intrinsic coefficient.

According to equation (1), the source voltage V_S is representative of the gate voltage V_G and any gate voltage variations will be duplicated by the source one, as given by (2).

$$V_{S} = V_{G} - V_{T} - \sqrt{\frac{I_{DS}}{K} \frac{V_{A}}{V_{A} + V_{DS}}}$$
 (2)

Since the threshold voltage V_T and the Early's voltage V_A can be considered as constant whatever the electrical bias, the output voltage variations (i.e. the source potential V_S variations) can be determined as follows:

$$\frac{dV_S}{dV_{DS}} = \frac{1}{2} \sqrt{\frac{I_D V_A}{K}} (V_A + V_{DS})^{-\frac{3}{2}}$$
 (3)

It appears that the drain-source current I_{DS} must be low while the drain-source voltage V_{DS} must be high to minimize errors generated by the V_{DS} variations. Different measurements have shown that the worst FET transistor has an Early's voltage V_A ranging between 35V and 105V. As the MOSFET transistor intrinsic coefficient K is a constant parameter (estimated around $16 \times 10^{-5} \text{ A/V}^2$) and according to our data and to the standard electrical bias used ($I_{DS} = 250 \mu \text{A}$, $V_{DS} = 2 \text{V}$), these errors are shown to be lower than 1%, demonstrating the efficiency of our measurement principle.

B. Electronic scheme

Since all MOSFET devices were collectively fabricated on the same chip, they have similar electrical behaviour (dispersion lower than 1%). Typical current-voltage characteristics are presented in Fig. 5, evidencing a threshold voltage V_T around 1.2 V and a I_{on}/I_{off} ratio higher than 3000. As a result, since current mirrors insure the current generation to insure that all drain-source current values I_{DS} are similar (Fig. 6) and in the absence of any stimulation signal, all the transistor gates are at the same potential. Due to the chosen electronic scheme, all the transistors are biased in the same way while the V_{DS} voltage value is fixed on one transistor only (Fig. 6). The source voltage being imposed by the gate, the drain voltage is automatically set at $V_S + V_{DS}$ voltage (from the feedback) and it is imposed to all the transistors. Finally, the source potentials of the different FET devices (from V_{SI} to V_{Sn}) are used as output voltages (from V_{out0-I} to V_{out0-I}), allowing to monitor multiple chemical variation signals V_{out0-I} (Fig.5).

Since all the FET transistors gates are in contact with the liquid media, one has to be able to avoid the electrochemical noise/interference that might affect the accuracy of the final measurement results. For this to be achieved, a differential amplifier is implemented next to the $(V_{out0-1} - V_{out0-n})$ level in order to subtract the gate voltage (and its electrochemical noise) from the different output voltages (Fig. 7).

Finally, the transfer equation (between V_{out0-i} and V_{out1-i}) of this amplifier is given by equation (4).

$$V_{o kn} = (k+1)(V_{o 0n} - V_{No})$$
 (4)

In our case, the k factor was chosen equal to 1 according to electronic devices, leading to a final amplification gain of 2. Finally, the last amplification stage allows removing the DC components (typical frequencies lower than 200 mHz) by means of a high-pass filter with a gain of 1.

C. Electronic simulation

Before realizing the electronic device, simulation was performed using P-Spice. An "action potential-like" shape was chosen as modelof the input biological electrical signal to be measured by the FETs sensing platform. This signal has a resting potential around -70mV and variation of 130mV from peak to peak (Fig. 8 a). The liquid phase noise V_{Noise} was assumed to be a sinusoidal signal with a voltage of 1V from peak to peak and a frequence of 800 Hz (not shown). This signal was deliberately chosen with a large amplitude to study the performances of our measurement system. Action potential signals are simulated on V_{in1} , V_{in2} and V_{in3} sequentially whereas V_{Noise} is simulated on V_{inn} . Output of V_{out2-1} is shown in Fig. 8 b), evidencing the correct measurement of the action potential signal sent on V_{in1} . The field noise voltage has been decreased as shown in Fig. 6 c) on the V_{out2-n} signal. All other signals are returned with insignificant noise field and an amplification of 2.

From the V_{out2-n} signal, the amplitude is estimated at 2 mV peak to peak. Whatever the signal frequency (and therefore the 800 Hz interfering noise), the gain of the common mode G_{CM} is given by the equation (5). According to our experimental results, the G_{CM} value was estimated around to $2x10^{-3}$ (or a Common Mode Rejection Ratio (CMRR) around 54dB).

$$G_{CM} = \left(\frac{V_{o} = 1}{V_{No}}\right) \tag{5}$$

D. Test in liquid media

The SiO₂/Si₃N₄ pH-chemFETs were characterized using the gold wire or the Ag/AgCl commercial reference electrode in order to bias a liquid solution which pH variation has to be assessed. In this conventional configuration, a pH-sensitivity around 50 mV/pH was determined which is in good agreement with previous results [18,20] (Fig. 9). However, the use of the Ti/Au integrated microelectrode was responsible for an important sensitivity decrease resulting in a 28 mV/pH final value. Such phenomenon might be due to electrochemical defects related to the gold surface and/or to the titanium underlayer. Nevertheless, such results were obtained whatever the pH-ChemFET transistors tested, demonstrating the reproducibility of our technological process.

The MOSFET devices were first tested in PBS solution by pairs (at least). Using the integrated Ti/Au electrode, measurements of action potential-like voltages were polluted by other signals in the liquid phase as shown in figure 10 a) and b). The signal to noise ratio was estimated around 2.3. On the contrary, with the gold wire or with the Ag/AgCl commercial reference (Fig 8 c and d) and as previously for the pH measurement, results are improved since no parasitic signals were evidenced. In fact, in this latter case, the signal to noise ratio was estimated at 15.5. These results were confirmed through the liquid noise measurement using a non-stimulated MOSFET transistor. For the integrated Ti/Au microelectrode (Fig. 11 a), all the different action potential-like signals were fully recorded while none of them were evidenced when the gold wire or the commercial Ag/AgCl reference electrode was used (Fig. 11 b). Finally, since identical results were obtained in the DMEM culture field, the good use of these two last electrodes was demonstrated for the monitoring of neuronal cultures.

Finally, deionized water was also tested in such configuration. Again, the efficiency of the gold wire or of the Ag/AgCl commercial electrode was confirmed. Nevertheless better results were obtained since the signal to noise ratio was around 2.9 for the Ti/Au integrated microelectrode and up to 25 for the other ones. Such improvements are due to the much higher resistivity of deionized water ($\sim 10~\text{M}\Omega.\text{cm}$) compared to the PBS solution ($\sim 50~\Omega.\text{cm}$).

Conclusion

In this article, a FET-based (MOSFET/ChemFET) sensing platform dedicated to bioelectrical measurements in liquid media has been fabricated and successfully tested due to an innovative chip/support assembling technique combining screen printing and flip chip methods. A specific associated electronics scheme has been implemented to exploit the transistors saturation regime in order to both measure pH variation (static mode) and bioelectrical signals variation (dynamic mode). Electrical tests in liquid phase have shown a modification of signal on noise ratio between deionized water and phosphate buffer solution / DMEM culture field solution, as well as between gold microelectrode integrated on chip and gold wire commercial electrode. Hence, by studying different kinds of liquids and different electrodes to bias the liquid phase, the liquid noise voltage was reduced by more than 20dB. All MOSFET tests were realized providing action potential-like signals generation thus demonstrating that the system could be used to measure neuronal activities.

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Biographies

Florian Larramendy was born in Brive-la-Gaillarde, France, in 1986. He received the M.S. degree in microelectronic system engineering from the Paul Sabatier University, Toulouse, France, in 2009. He joined the Laboratory for Analysis and Architecture of Systems (LAAS), National Center of Scientific Research (CNRS), Toulouse in 2009 as PhD student. He is in charge of the development of microsystems to measure neuronal activities.

Fabrice Mathieu was born in Orléans, France, in 1972. He received the engineering degree in communication systems and electronics from the CNAM (Conservatoire National des Arts et Métiers), Toulouse, France, in 2003. He joined the Laboratoire d'Analyse et d'Architecture des Systèmes (LAAS), Centre National de la Recherche Scientifique (CNRS), Toulouse, in 2001, where he is currently in charge of the development and design of very low signal detection systems applied to the micro(nano)electromechanical systems area and its complete electronic treatment and control for automation.

Samuel Charlot was born in 1979, he received the master degree in Materials and Micro Technology from the Var Institute of Technology, Toulon, France in 2004. From 2004 to 2006, he worked on the development of microfluidics systems in LAAS-CNRS, Toulouse, France. In 2006, he worked in the packaging of oxygen sensor at Néosens, Labège, France. From 2007 to 2008, he worked on a low cost technology for the integration of sensors silicon in polymer microfluidic systems in LAAS-CNRS, Toulouse, France. Since 2008, he works on

packaging area and more specifically in screen printing technology and flip chip interconnect technology in the team packaging in LAAS-CNRS, Toulouse, France.

Liviu Nicu was born in 1973 in Bucharest (Romania). After completing his master of electrical engineering at the Paul Sabatier University of Toulouse (France) in 1997, he joined the Integrated Microsystems Group at the LAAS (Laboratory for Analysis and Architecture of Systems) of Toulouse where he obtained his PhD. in 2000 into the Micromechanical Structures field. From 2000 to 2003, he was R&D Engineer at Thales Avionics, Valence (France). His activities focused onto the development of micromechanical sensors for the civil and military navigation applications. Since 2003 he joined the NanoBioSystems Group at LAAS as a full time CNRS (National Center of Scientific Research) researcher where he currently works in two main research fields: the development of (1) new resonant bio(chemical)sensors using M(N)EMS technologies and of (2) cantilever-based microsystems for contact deposition of small amounts of biological samples for biochip applications.

Pierre Temple-Boyer was born in Montpellier (France) in 1966. He received his engineering master's degree in electronic from the Ecole Supérieure d'Electricité (Paris – France) in 1990 and his master's degree in microelectronics from the Université Paul Sabatier de Toulouse (France) in 1992. He joined the Laboratoire d'Architecture et d'Analyse des Systèmes of the French Centre National de la Recherche Scientifique (LAAS-CNRS) in 1992 and received the PhD degree from the Institut National des Sciences Appliquées de Toulouse (France) in 1995. Since then, as a senior researcher, he has been working on the development of micro- and nanotechnologies.

Figures caption

- Fig.1: Schematic of the SiO₂/Si₃N₄/Ti/Au MOSFET device
 - Fig. 2: a) Photograph of the MOSFET/ChemFET chip and b) SU8-passivated MOSFET chip
- Fig. 3: a) Photograph of bump deposit on PCB by screen printing technique and b) chip mounted on specific PCB
 - Fig. 4: Photograph of final packaging
- Fig. 5: MOSFET electrical charateristics: Drain Source Current IDS as a function of Drain Source and Gate Source Voltages V_{DS} and V_{GS}
 - Fig 6: Schematic view of the polarization system
 - Fig. 7: Schematic view of the amplification system
 - Fig. 8: a) Action potential implemented on V_{in1} , b) amplification system output V_{out2-1} and c) noise in V_{out2-n} output
 - Fig. 9: pH-ChemFET analytical response (tested on 70 microdevices)
 - Fig. 10: MOSFET measurements of action potential-like signals in PBS or DMEM with the Ti/Au microelectrode integrated on chip
 - a) on transistor 1, b) on transistor 2 and c) on the others transistors TX
 - Fig. 11: MOSFET measurements of action potential-like signals in PBS or DMEM with the commercial electrode or the gold wire
 - a) on transistor 1, b) on transistor 2 and c) on the others transistors TX

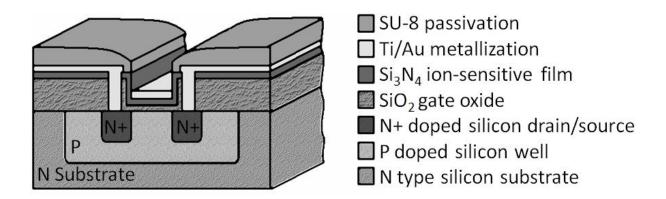


Fig.1: Schematic of the SiO₂/Si₃N₄/Ti/Au MOSFET device

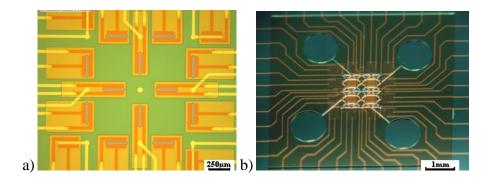


Fig. 2: a) Photograph of the MOSFET/ChemFET chip and b) SU8-passivated MOSFET chip

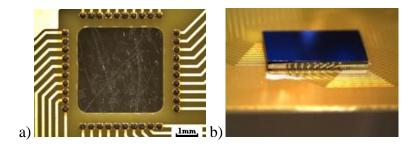


Fig. 3: a) Photograph of bump deposit on PCB by screen printing technique and b) chip mounted on specific PCB

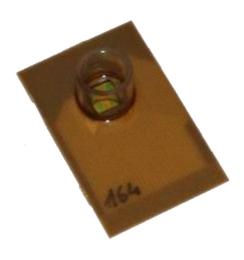
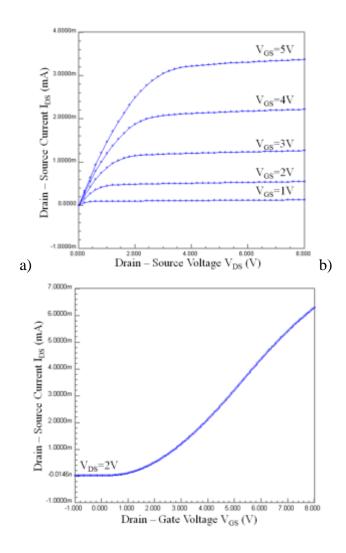


Fig. 4: Photograph of final packaging



 $\label{eq:source_source} Fig. \, 5: MOSFET \, electrical \, characteristics: \, Drain \, - \, Source \, Current \, I_{DS} \, as \, a \, function \, of \, Drain \, - \, Source \, and \, Gate \, - \, Source \, Voltages \, V_{DS} \, and \, V_{GS} \, respectively$

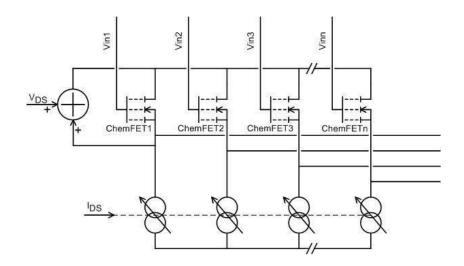


Fig 6: Schematic view of the polarization system

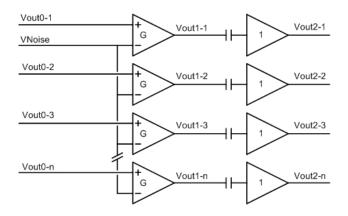


Fig. 7: Schematic view of the amplification system

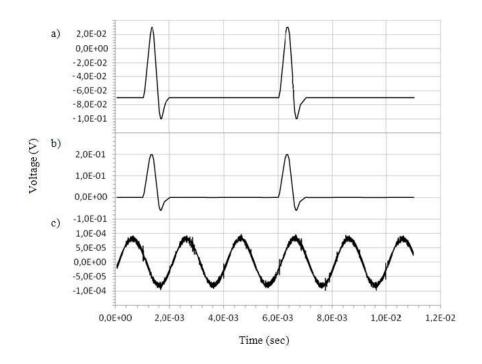


Fig. 8: a) Action potential implemented on V_{in1} b) amplification system output V_{out2-1} and c) noise in V_{out2-n} output

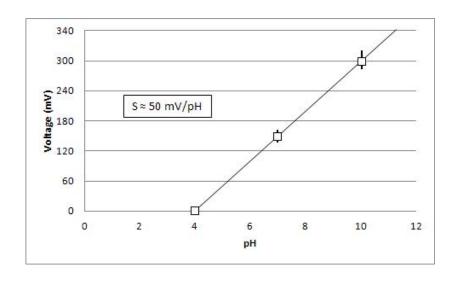


Fig. 9: pH-ChemFET analytical response (tested on 70 microdevices)

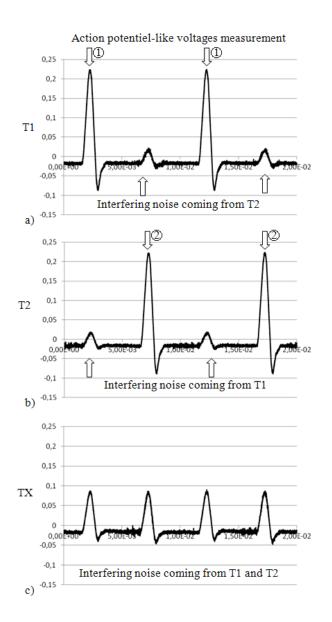


Fig. 10 : MOSFET measurements of action potential-like signals in PBS or DMEM with the Ti/Au microelectrode integrated on chip

a) on transistor 1, b) on transistor 2 and c) on the others transistors TX

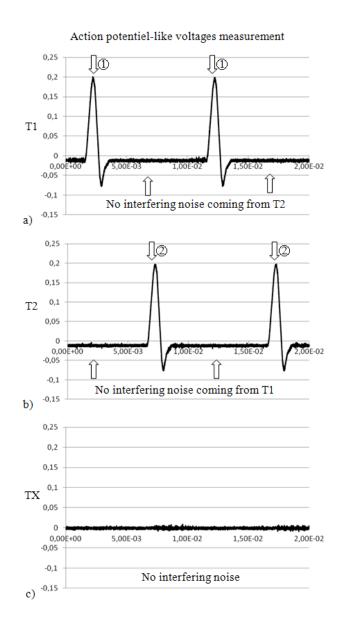


Fig. 11: MOSFET measurements of action potential-like signals in PBS or DMEM with the commercial electrode or the gold wire

a) on transistor T1, b) on transistor T2 and c) on the others transistors TX